

● Description

The NAQY214 series is robust, ideal for telecom and ground fault applications. It is a SPST normally open switch (1 Form A) that replaces electromechanical relays in many applications. It is constructed using a GaAlAs LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high-voltage dielectrically isolated technology, is comprised of a photodiode array, switch control circuitry and MOSFET switches.

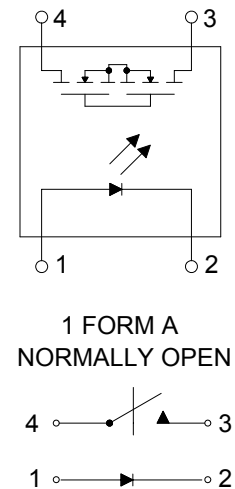
● Features

1. Normally open, single pole single throw
2. Control 400V AC or DC voltage
3. Switch 130mA loads
4. Controls low-level analog signals
5. High sensitivity, low ON resistance
6. Low-level off-state leakage current
7. High isolation voltage 5KV (DIP / SMD)
8. Pb free and RoHS compliant
9. MSL class 1
10. Agency Approvals :
 - UL Approved (No. E108430): UL508
 - c-UL Approved (No. E108430)
 - FIMKO Approved: EN60950

● Application

- Telecommunications (PC, electronic notepad)
- Modem
- Telephone equipment
- Security equipment
- Sensors
- Measuring and testing equipment
- Factory automation equipment
- High speed inspection machines

● Schematic



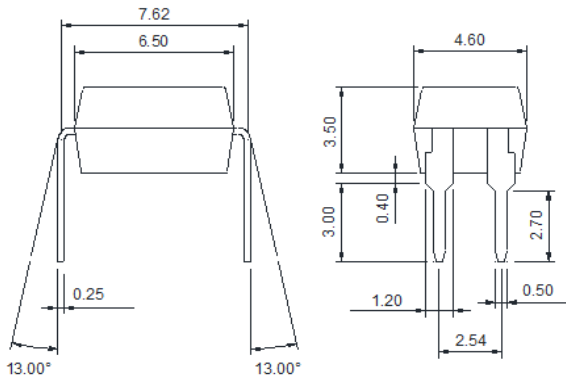
● **Outside Dimension**

Unit : mm

1. Dual-in-line type.



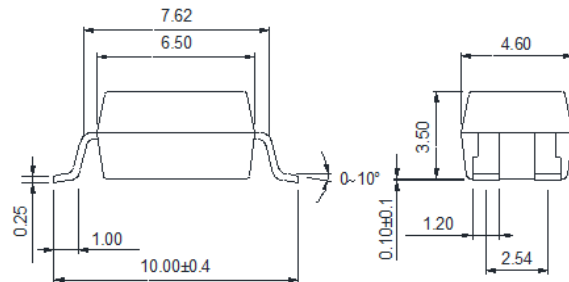
NAQY214



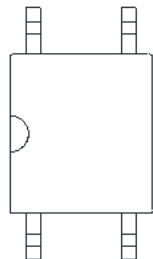
2. Surface mount type.



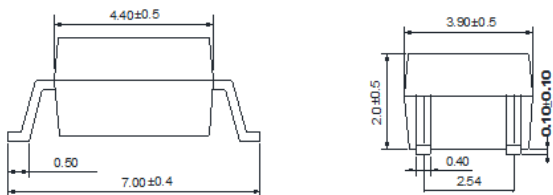
NAQY214A



3. Small outline for surface mount type.

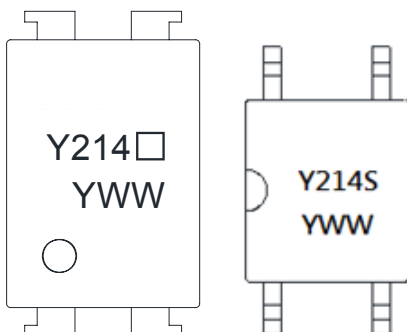


NAQY214S



TOLERANCE : ±0.2mm

● **Device Marking**



Notes :

Y214□ □(Blank) : DIP or SMD
 Y214S S : SOP
 YWW Y : Year code / W : Week code

● Absolute Maximum Ratings

(Ta=25°C)

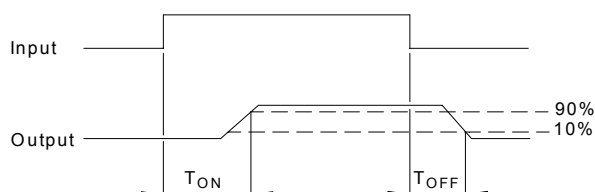
Item		Symbol	Rating	Unit
Input	Continuous forward current	I_F	50	mA
	Peak forward current	I_{FP}	1	A
	Reverse voltage	V_R	5	V
	Power dissipation	P_{in}	100	mW
	Derate linearly from 25°C	-	1.3	mW/°C
Output	Breakdown voltage	V_B	400	V
	Continuous load current	I_L	130	mA
	Power dissipation	P_{out}	500	mW
Isolation voltage		V_{iso}	NAQY214S	NAQY214
			1500Vrms	5000Vrms
Isolation resistance (Vio=500V)		R_{iso}	$\geq 10^{10}$	Ω
Total power dissipation		P_t	550	mW
Derate linearly from 25°C		-	2.5	mW/°C
Operating temperature		T_{opr}	-40 to +85	°C
Storage temperature		T_{stg}	-40 to +125	°C
Junction temperature		T_j	100	°C
Soldering temperature 10 seconds		T_{sot}	260	°C

● Electro-optical Characteristics

(Ta=25°C)

Parameter		Symbol	Conditions	Min.	Typ.	Max.	Unit
Input	Forward voltage	V_F	$I_F=10\text{mA}$	-	1.2	1.5	V
	Operation input current	I_{FON}	$V_L=20\text{V}, I_L=100\text{mA}$	-	-	3.0	mA
	Recovery input current	I_{FOFF}	$V_L=20\text{V}, I_L \leq 5\mu\text{A}$	0.2	-	-	mA
Output	Breakdown voltage	V_B	$I_B=50\mu\text{A}$	400	-	-	V
	Off-state leakage current	I_{LEAK}	$V_L=400\text{V}, I_F=0\text{mA}$	-	0.2	1.0	μA
I/O capacitance		C_{iso}	$V_B=0\text{V}, f=1\text{MHz}$	-	6	-	pF
ON resistance		R_{ON}	$I_F=10\text{mA}, I_L=100\text{mA}$	-	20	30	Ω
Turn-on time		T_{ON}	$I_F=10\text{mA}, V_L=20\text{V}$	-	0.3	1.0	ms
Turn-off Time		T_{OFF}	$I_L=100\text{mA}, t=10\text{ms}$	-	0.1	1.0	ms

● Turn-on / Turn-off Time



● Schematic and Wiring Diagrams

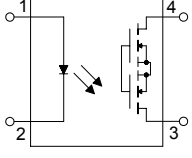
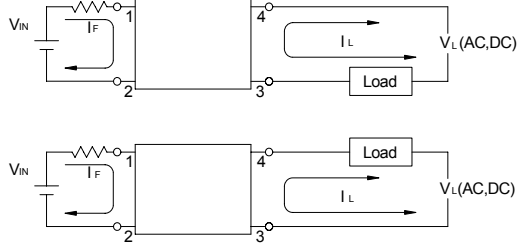
Schematic	Output Configuration	Load	Connection	Wiring Diagrams
	1a	AC DC	-	

Fig.1 Load Current vs. Ambient Temperature

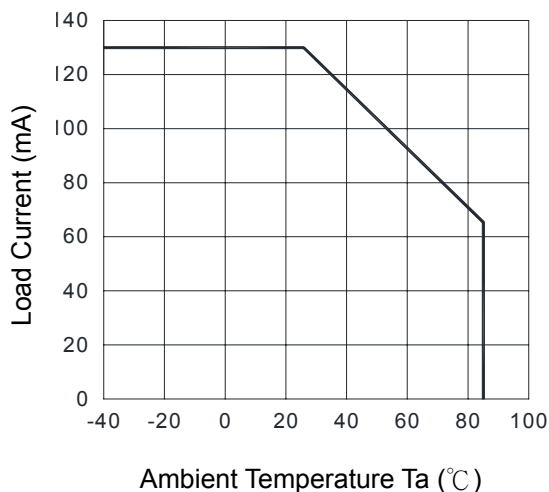


Fig.2 On Resistance vs. Ambient Temperature

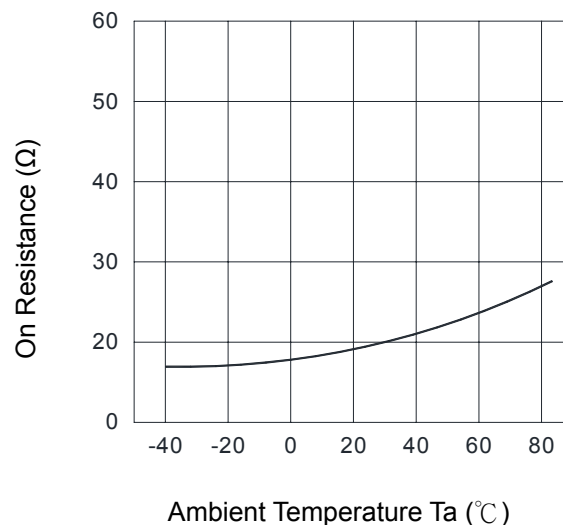


Fig.3 Turn-on Time vs. Ambient Temperature

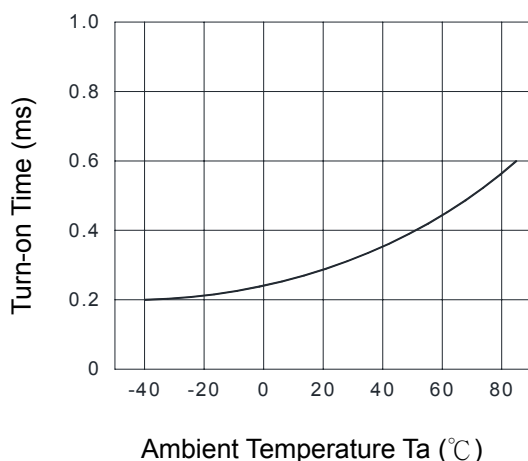


Fig.4 Turn-off Time vs. Ambient Temperature

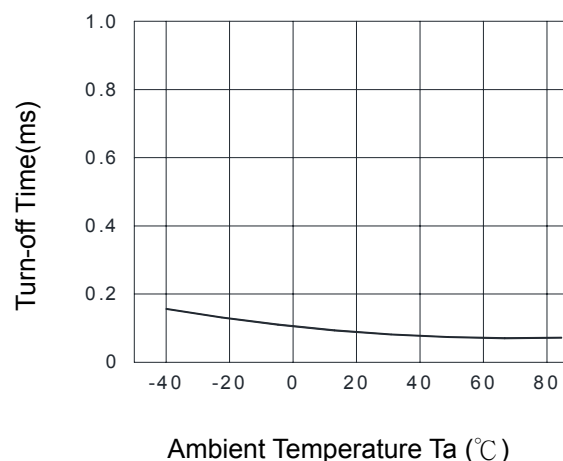


Fig.5 LED Operate Current vs. Ambient Temperature

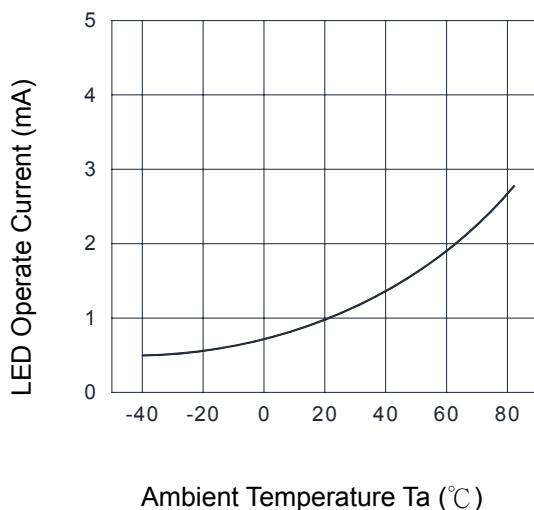


Fig.6 LED Turn-off Current vs. Ambient Temperature

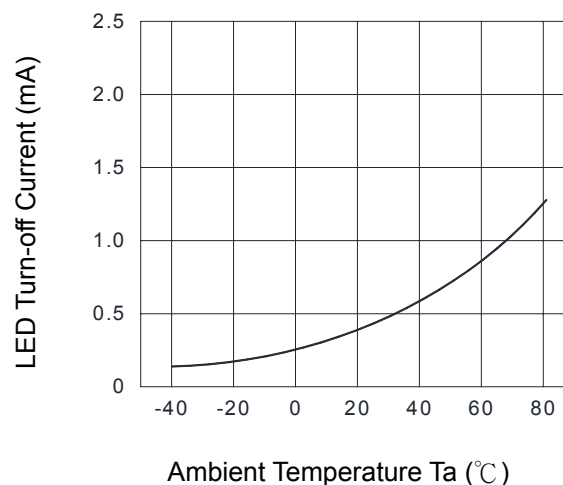


Fig.7 LED Dropout Voltage vs. Ambient Temperature

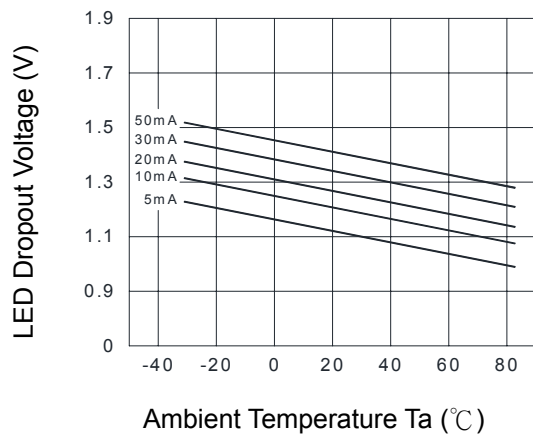


Fig.8 Voltage vs. Current Characteristics of Output at MOSFET Portion

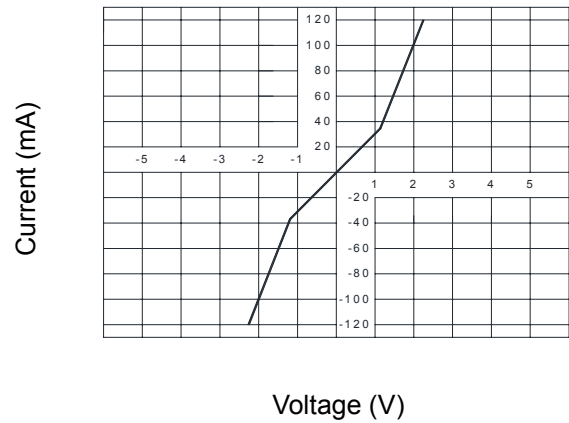


Fig.9 Turn-on Time vs. LED Forward Current

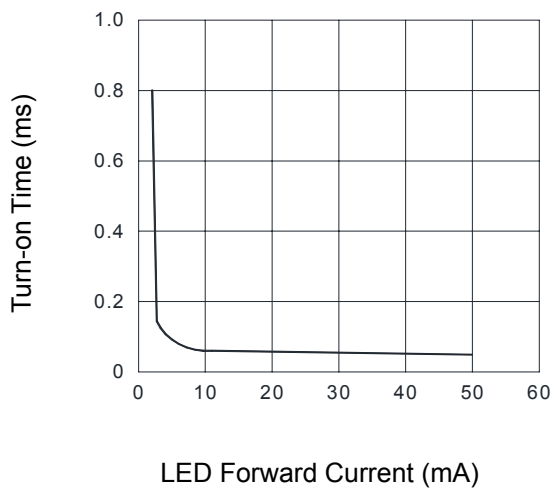


Fig.10 Off-state Leakage Current vs. Load Voltage

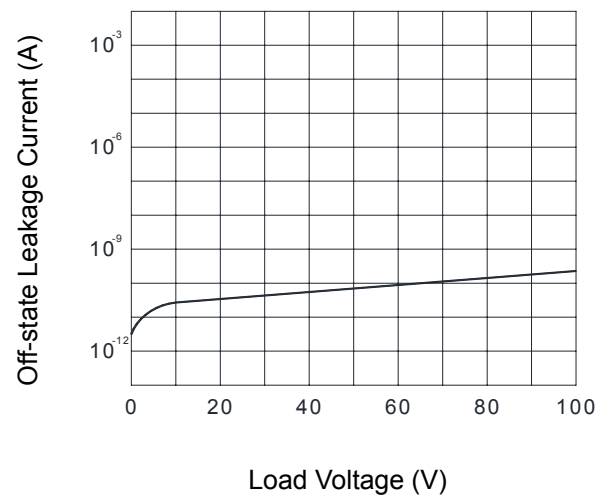


Fig.11 Turn-off Time vs. LED Forward Current

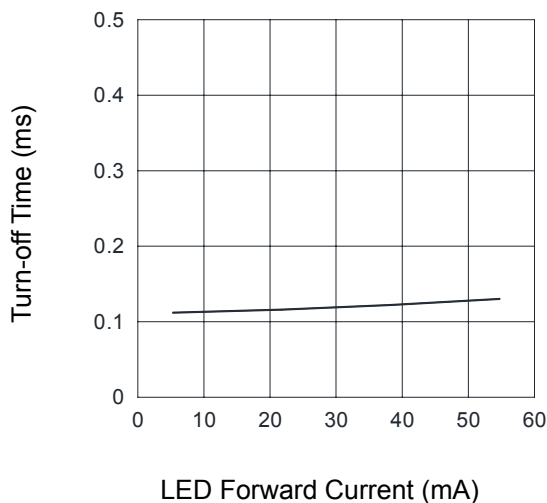
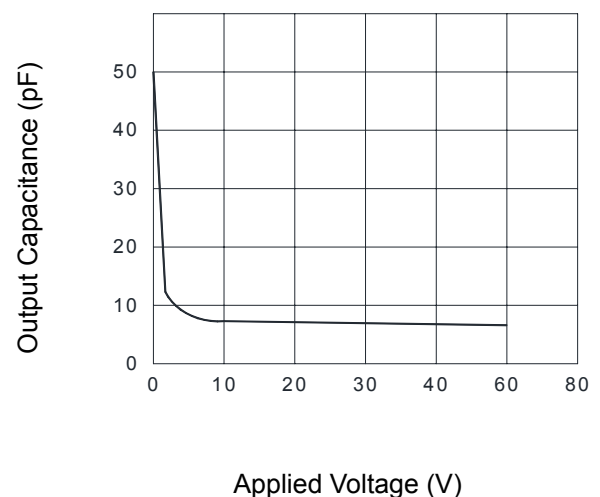
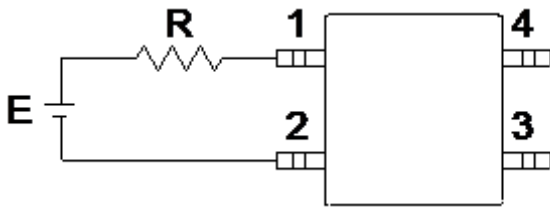


Fig.12 Output Capacitance vs. Applied Voltage



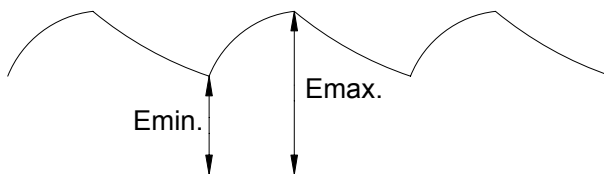
● Using Methods

Examples of resistance value to control LED forward current ($I_F=5\text{mA}$)

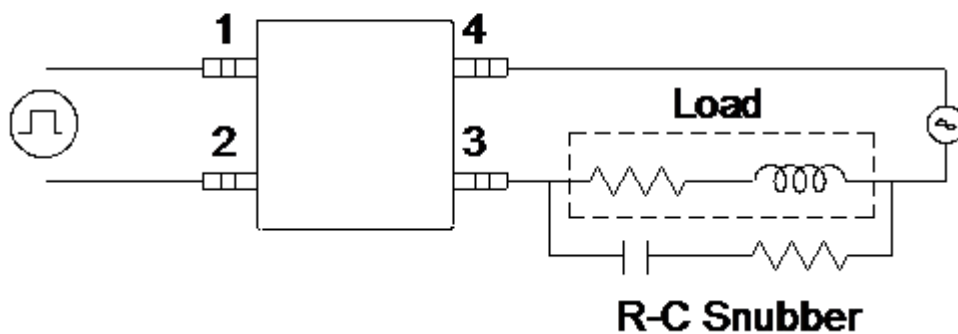
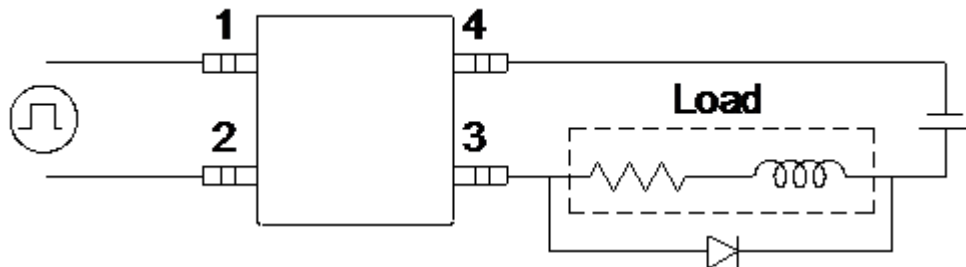


E	R
3.3V	Approx. 330 Ω
5V	Approx. 640 Ω
12V	Approx. 1.9K Ω
15V	Approx. 2.5K Ω
24V	Approx. 4.1K Ω

1. LED forward current must be more than 5mA , at E min.
2. LED forward current must be less than 50mA , at E max.



Regulate the spike voltage generated on the inductive load as follows :

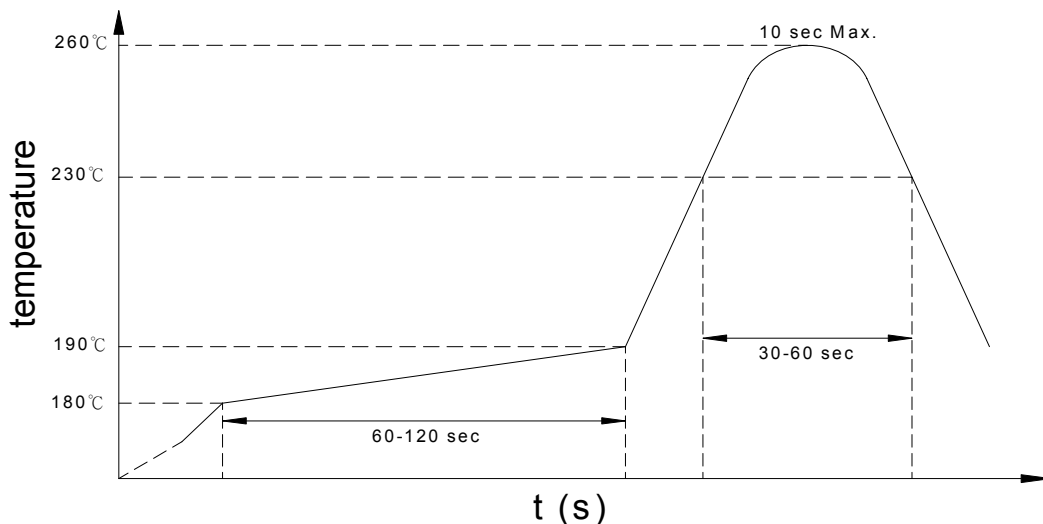


● **Recommended Soldering Conditions**

(a) Infrared reflow soldering :

- Peak reflow soldering : 260°C or below (package surface temperature)
- Time of peak reflow temperature: 10 sec
- Time of temperature higher than 230°C : 30-60 sec
- Time to preheat temperature from 180~190°C : 60-120 sec
- Number of reflows : Rosin flux containing small amount of chlorine
- Flux : (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(b) Wave soldering :

- Temperature : 260°C or below (molten solder temperature)
- Time : 10 seconds or less
- Preheating conditions: 120°C or below (package surface temperature)
- Number of times : One
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(c) Cautions :

- Fluxes : Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
- Avoid shorting between portion of frame and leads.

● **Numbering System**

NAQY214 X (Y)

Note :

NAQY214 = Part No.

X = Lead form option (blank 、 S or A)

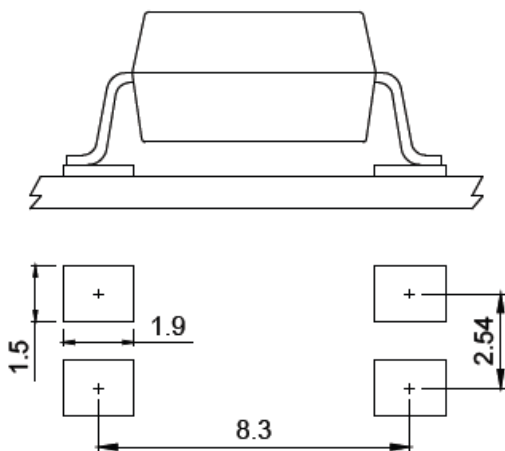
Y = Tape and reel option (TLD 、 TRU)

Option	Description	Packing quantity
A (TLD)	surface mount type package + TLD tape & reel option	2000 units per reel
A (TRU)	surface mount type package + TRU tape & reel option	2000 units per reel
S (TLD)	small outline for surface mount type package + TLD tape & reel option	3000 units per reel
S (TRU)	small outline for surface mount type package + TRU tape & reel option	3000 units per reel

● **Recommended Pad Layout for Surface Mount Lead Form**

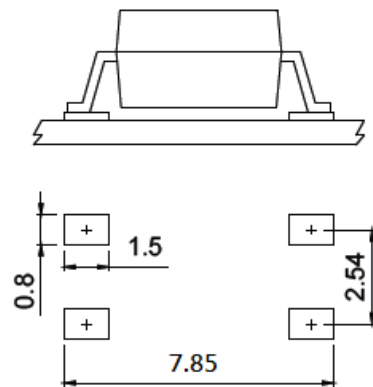
1. Surface mount type.

4-pin SMD



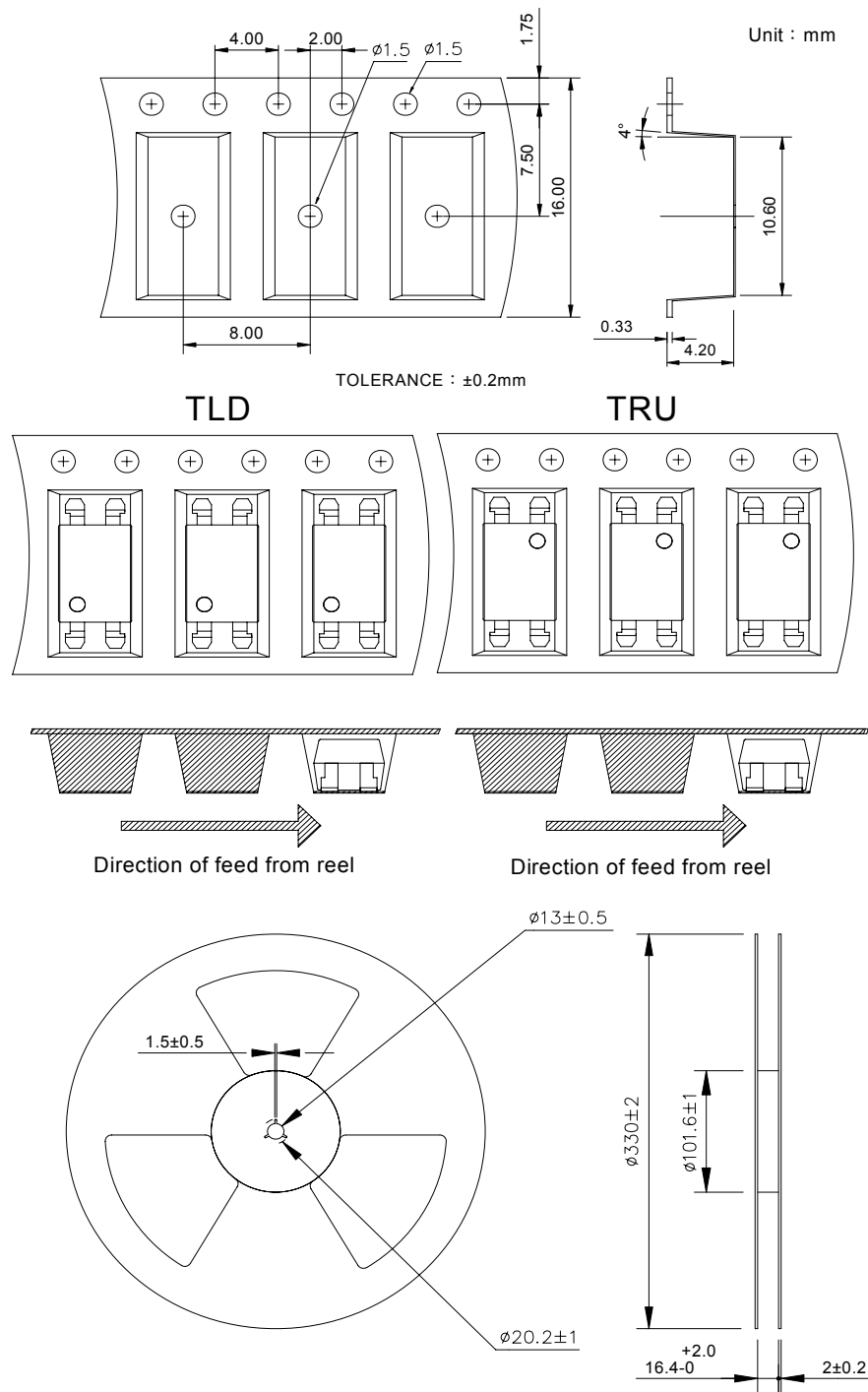
2. Small outline for surface mount type.

4-pin SOP



Unit : mm

● 4-pin SMD Carrier Tape & Reel



● 4-pin SOP Carrier Tape & Reel

